

	Type	Hits	Search Text	DBs	Time Stamp
1	BRS	3990	micro adj spring interconnect and sensor and (LED or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:19
2	BRS	0	micro adj spring adj interconnect and sensor and (LED or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 15:57
3	BRS	1	spring adj interconnect and sensor and (LED or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 15:58
4	BRS	7	anchor near interconnect and sensor and (LED or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 16:06
5	BRS	2	twist\$ near interconnect and sensor and (LED or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 16:07
6	BRS	3951	interconnect and sensor and (LED or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 16:09
7	BRS	602	deform\$ and interconnect and sensor and (LED or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 16:17
8	BRS	1430	spring and interconnect and sensor and (LED or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 16:19
9	BRS	402	spring adj (interconnect or wire or contact) and sensor and (LED or laser)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 16:23
10	BRS	334	spring adj (interconnect or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/03 19:32

	Type	Hits	Search Text	DBs	Time Stamp
11	BRS	448	(spring\$ or deform\$) adj (interconnect or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 17:10
12	BRS	4	257/\$.ccls. and (spring\$ or deform\$) adj (interconnect or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 17:19
13	BRS	29	361/\$.ccls. and (spring\$ or deform\$) adj (interconnect or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 17:35
14	BRS	4	257/\$.ccls. and (spring\$ or deform\$) adj (interconnect or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 17:36
15	BRS	4	257/\$.ccls. and (spring\$ or deform\$) near (interconnect or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 17:38
16	BRS	942	257/\$.ccls. and (interconnect or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 17:39
17	BRS	4	257/\$.ccls. and (spring\$ or deform\$) near (interconnect or lead or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 17:40
18	BRS	93	257/\$.ccls. and (spring\$ or deform\$) same (interconnect or lead or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 13:06

	Type	Hits	Search Text	DBs	Time Stamp
19	BRS	124	438/\$.ccls. and (spring\$ or deform\$) same (interconnect or lead or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 13:46
20	BRS	64	438/\$.ccls. and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$) same (interconnect or lead or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 14:18
21	BRS	71	257/\$.ccls. and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$) same (interconnect or lead or wire or contact) and sensor and (LED or laser) and (chip or die or circuit or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 14:42
22	BRS	27	257/\$.ccls. and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$) same (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chip or die or circuit or IC) and (glue or elastic\$ or adhesive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 15:07
23	BRS	1	257/688 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$) same (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chip or die or circuit or IC) and (glue or elastic\$ or adhesive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 15:16

	Type	Hits	Search Text	DBs	Time Stamp
24	BRS	6	257/678 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$) same (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chip or die or circuit or IC) and (glue or elastic\$ or adhesive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 15:23
25	BRS	6	257/678 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$) same (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 15:27
26	BRS	1	257/688 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$) same (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 15:29
27	BRS	2	257/689 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$) same (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 15:41
28	BRS	3	257/690 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$) same (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 15:47

	Type	Hits	Search Text	DBs	Time Stamp
29	BRS	4	257/\$.ccls. and (curve\$ or arch\$ or round\$ or basket-handle\$ or , horseshoe\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 15:55
30	BRS	149	(curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 15:59
31	BRS	417	(curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$ or flexible\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 20:19
32	BRS	2	(curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$ or flexible\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	JPO	2001/07/31 18:35
33	BRS	462	(interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	JPO	2001/08/03 17:43
34	BRS	0	257/80 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$ or flexible\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 20:23

	Type	Hits	Search Text	DBs	Time Stamp
35	BRS	0	257/81 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$ or flexible\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 20:25
36	BRS	0	257/82 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$ or flexible\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 20:29
37	BRS	0	257/83 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$ or flexible\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 20:31
38	BRS	0	257/84 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$ or flexible\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 20:34
39	BRS	0	257/91 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$ or flexible\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 20:36
40	BRS	0	257/696 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$ or flexible\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 20:39

	Type	Hits	Search Text	DBs	Time Stamp
41	BRS	2	257/700 and (curve\$ or arch\$ or round\$ or basket-handle\$ or horseshoe\$ 'or flexible\$) adj (interconnect or leads or wires or contacts) and sensor and (LED or laser) and (chips or dice or circuits or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/31 20:48
42	BRS	184595	micro adj spring interconnect	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/07/30 15:56
43	BRS	3	sensor and conductive adj layer and active adj layer and transpa\$ adj layer and passivation and via and metal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:52
44	BRS	0	sensor and amorphous adj silicon and n+ adj doped and n+ adj phosphorous and n+ adj arsenic and p+ and intrinsic adj amorphous	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:30
45	BRS	0	amorphous adj silicon and n+ adj doped and n+ adj phosphorous and n+ adj arsenic and p+ and intrinsic adj amorphous	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:30
46	BRS	4056	sensor and amorphous adj silicon	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:37
47	BRS	228	amorphous adj silicon and n+ adj doped	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:39
48	BRS	2	amorphous adj silicon and n+ adj doped and n+ adj phosphorous	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:45
49	BRS	0	amorphous adj silicon and n+ adj doped and n+ adj phosphorous and arsenic and p+ and intrinsic adj amorphous	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:47

	Type	Hits	Search Text	DBs	Time Stamp
50	BRS	2	n+ adj doped adj amorphous adj silicon and intrinsic adj amorphous adj silicon and p+ adj doped	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:48
51	BRS	0	sensor and conductive adj layer and active adj layer and transpa\$ adj layer and passivation and via and metal and absorption and (TFT or thin adj film adj transistor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:55
52	BRS	0	sensor and conductive adj layer and active adj layer and transpa\$ adj layer and passivation and via and metal and absorp\$ and (TFT or thin adj film adj transistor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:56
53	BRS	3	sensor and conductive adj layer and active adj layer and transpa\$ adj layer and passivation and via and metal and absorp\$	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 21:21
54	BRS	0	sensor and conductive adj layer and active adj layer and transpa\$ adj layer and passivation and via and metal and absorp\$ and switch	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 20:58
55	BRS	0	conductive adj layer and active adj layer and transpa\$ adj layer and passivation and via and metal and absorp\$ and (TFT or thin adj film adj transistor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 21:00
56	BRS	0	sensor and conductive adj layer and active adj layer and transpa\$ adj layer and passivation and via and metal and absorp\$ adj layer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 21:01
57	BRS	0	sensor and conductive adj layer and active adj layer and transpa\$ adj layer and passivation and via and metal and absorp\$ adj film	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2001/08/02 21:02



	Type	Hits	Search Text	DBs	Time Stamp
58	BRS	3	conductive adj layer and active adj layer and transpa\$ adj layer.and passivation and via and metal and absorp\$	USPAT	2001/08/02 21:23
59	BRS	52	conductive adj layer and active and transpa\$ and passivation and via and (metal or wire) and absorp\$	USPAT	2001/08/03 12:39
60	BRS	17	(sensor or detector) and conductive adj layer and active and transpa\$ and passivation and via and (metal or wire) and absorp\$	USPAT	2001/08/03 13:25
61	BRS	3	(sensor or detector) and conductive adj layer and active and transpa\$ and passivation and via and (metal or wire or plug or stud) and absorp\$ adj (layer or film)	USPAT	2001/08/03 14:06
62	BRS	0	(sensor or detector) and conductive adj layer and active and transpa\$ and (passivation same via) and (metal or wire or plug or stud) and absorp\$ adj (layer or film)	USPAT	2001/08/03 13:38
63	BRS	8	conductive adj layer and active and transpa\$ and (passivation same via) and (metal or wire or plug or stud) and absorp\$	USPAT	2001/08/03 13:39
64	BRS	3	(sensor or detector) and conductive adj layer and active and transpa\$ and passivation and (via or hole or cavity or opening) and (metal or wire or plug or stud) and absorp\$ adj (layer or film)	USPAT	2001/08/03 14:07

	Type	Hits	Search Text	DBs	Time Stamp
1	BRS	462	(interconnect or leads or wires or contacts) and sensor and '(LED, or laser) and (chips or dice or circuits or IC)	JPO	2001/08/03 18:18
2	BRS	0	driver adj chip and comparator and converter and register and signal and driver	JPO	2001/08/03 18:21
3	BRS	7	comparator and converter and register and signal and driver	JPO	2001/08/03 18:21
4	BRS	76	driver adj chip and comparator and converter and register and signal and driver	USPAT	2001/08/03 18:23
5	BRS	47	driver adj chip and comparator and converter and register and signal and driver and sensor and (light or LED)	USPAT	2001/08/03 18:24
6	BRS	194	sensor and (LED or laser) and driver adj (chip )	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM TDB	2001/08/03 19:34
7	BRS	3	257/\$.ccls. and sensor and (LED or laser) and driver adj (chip )	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM TDB	2001/08/03 19:35
8	BRS	3166	sensor and (LED or laser) and driver adj (chip or die or circuit or IC)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM TDB	2001/08/03 19:56

	Type	Hits	Search Text	DBs	Time Stamp
9	BRS	3103	sensor and (LED or light adj source) and driver adj (chip or die or circuit or IC)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM TDB	2001/08/03 20:42
10	BRS	5	5475211.pn. or 6084650.pn. or 4812415.pn. or 5917603.pn. or 5917534.pn.	USPAT	2001/08/03 20:53
11	BRS	1	03085466.pn.	JPO	2001/08/03 20:59
12	BRS	1	03085466.pn.	JPO	2001/08/03 20:59